

## ENGR 1121 – Real World Measurements

January 21, 2014

During your first week in lab, you will receive some basic supplies that will allow you to prototype and power your circuits for the rest of the semester. You will receive a solderless breadboard, a 9-V plug-in power supply, and a USB cable. You will also receive a printed circuit board (PCB) and all of the components required to populate it. The PCB plugs into the power distribution rails of your solderless breadboard and provides you with ground, a 5-V power supply rail, and two 2.5-V reference rails. The plug-in power supply and the USB cable are also for use with your Arduino Uno later in the course. These items will be yours to keep in your toolboxes; they should prove useful to you beyond this course. We expect that you will bring your toolboxes with these items as well as your laptop to lab with you each week.

If you have not yet reviewed the soldering tutorials that we asked you to review before coming to lab, please review them before you begin. Obtain your materials, the bare PCB, and all of the components you need to assemble the board. Some of the components are quite small, so you might want to obtain those when you are actually able to get time on one of the soldering stations. To assemble your PCB, we recommend proceeding as follows:

1. Using the attached component map as a guide, solder all of the surface-mount components, paying careful attention to the orientation of the light-emitting diode (LED).
2. Solder the strip header pins using an old solderless breadboard as a jig to hold the pins in the proper place.
3. Solder the USB connector and the barrel jack power connector to the board.
4. Clean any flux residue off the board with isopropyl alcohol.

The basic procedure for soldering each surface-mount component with a soldering iron is as follows:

1. Using the applicator brush, apply some liquid flux to the component's pads.
2. Apply a small amount of solder to one of the pads (so there is a slight bulge visible).
3. Hold the component in place with a pair of tweezers while you heat the solder that you just applied to the pad with the soldering iron. That will hold the component in place while you apply solder to the other leads.
4. Lay a piece of fine-gauge solder along side the component leads on top of the pads. Bring the tip of the soldering iron into contact with the solder, the component lead, and the pad for just enough time to reflow the solder.
5. If necessary, apply more solder to the lead that you initially tacked down.

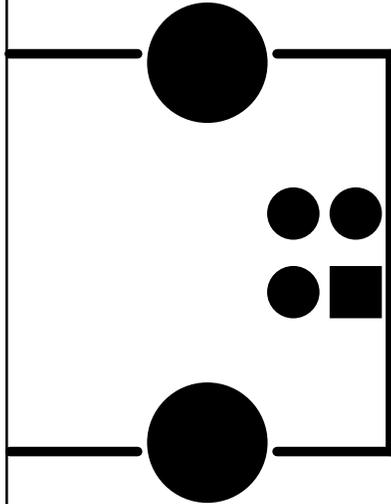
Once you have finished assembling your PCB, test it with your multimeter. Fix it if necessary.



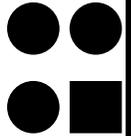
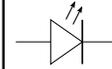
BAM  
1/8/2014

● ● ● ● ● 5V

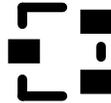
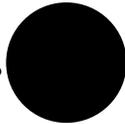
● ● ● 2.5V



402 Ω



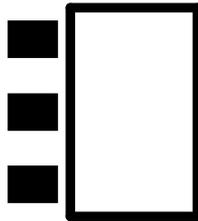
10 μF



MCP1525T



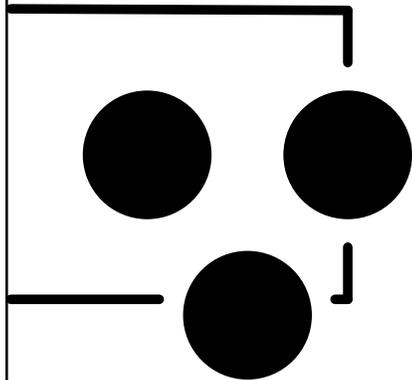
10 μF



AP1117E50G-13



10 μF



● ● ● 2.5V

● ● ● ● ● 0V

